

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patents issued thereon.

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As the below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name and that believe I am an original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

FLIP CHIP PROCESS

the spec	ification of whicl	h				
X is a	attached hereto.					
	s filed on					
as	Application Seri	al No	and was amended on			
specifica I a application I he application application priority is	ition, including the cknowledge the on in accordance ereby claim fore on(s) for patent o	ne claims, as amended duty to disclose info e with Title 37, Code of ign priority benefits un or inventor's certificate nventor's certificate ha	and understand the content of by any amendment referred formation which is material to of Federal Regulations, § 1.5 der Title 35, Untied States Co e listed below and have also in aving a filing date before that	d to above. the patent 66(a). code, § 119 dentified belo	ability of this of any foreign ow any foreign	
	Number	Country	Date Filed(yyyy/mm/dd)	Yes	No	
	89127631	Taiwan, R.O.C.	2000/12/22	X		
transact Jiawe Maria		ne Patent and Tradem (Reg. No. 43,33	6) Chanette Armstrong		39,081) 44,011)	
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